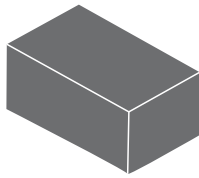
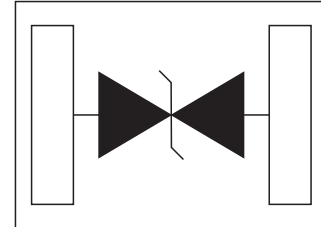


Electro-Static Discharge TESD05CB Bidirectional TVS Diode

DFN1006



Pin Configuration



Features

- 100 Watts Peak Pulse Power per Line ($t_p=8/20\mu s$)
- Protects one birectional I/O line
- Low clamping voltage
- Working voltages : 5V
- Low leakage current

IEC Compatibility

- IEC61000-4-2 (ESD) $\pm 25kV$ (air), $\pm 25kV$ (contact)
- IEC61000-4-4 (EFT) 40A (5/50ns)

Applications

- Cell Phone Handsets and Accessories
- Microprocessor based equipment
- Personal Digital Assistants (PDA's)
- Notebooks, Desktops, and Servers
- Portable Instrumentation
- Peripherals
- Pagers

Mechanical Characteristics

- JEDEC DFN1006 Package
- Molding Compound Flammability Rating : UL 94V-O
- Weight 0.5 Milligrams (Approximate)
- Quantity Per Reel : 10,000pcs
- Reel Size : 7 inch
- Lead Finish : Lead Free

Maximum Ratings($T_A=25^{\circ}\text{C}$ unless otherwise specified)

Parameter	Symbol	Value	Units
Peak Pulse Power($t_p=8/20\mu\text{s}$)	P_{PP}	100	Watts
Lead Soldering Temperature	T_L	260(10 sec.)	$^{\circ}\text{C}$
Operating Temperature Range	T_J	-55~150	$^{\circ}\text{C}$
Storage Temperature Range	T_{STG}	-55~150	$^{\circ}\text{C}$

Electrical Characteristics($T_A=25^{\circ}\text{C}$ unless otherwise specified)

TESD05CB(Marking: .H)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Reverse Stand-off Voltage	V_{RWM}				5	V
Breakdown Voltage	V_{BR}	$I_T=1\text{mA}$	5.6			V
Clamping Voltage	V_C	$I_{PP}=1\text{A}, t_p=8/20\mu\text{s}$			9.5	V
		$I_{PP}=4\text{A}, t_p=8/20\mu\text{s}$			15	V
Reverse Leakage Current	I_R	@ V_{RWM}			1	μA
Junction Capacitance	$C_{I/O}$	0Vdc, f=1MHz Between I/O Pins and GND		10		pF

Ratings and Characteristic Curves

Fig.1 Non-Repetitive Pulse Power vs.Pulse Time

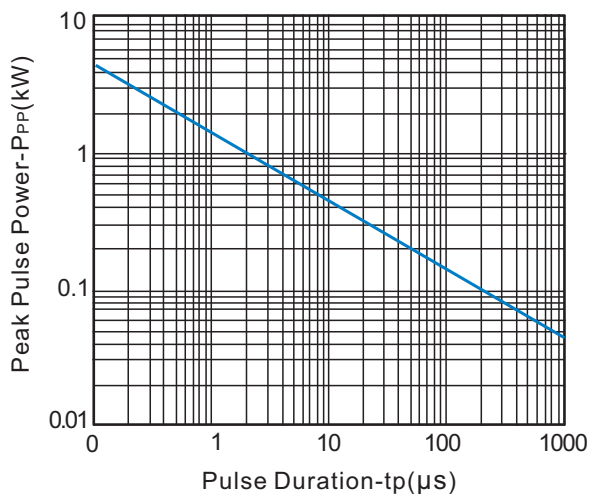
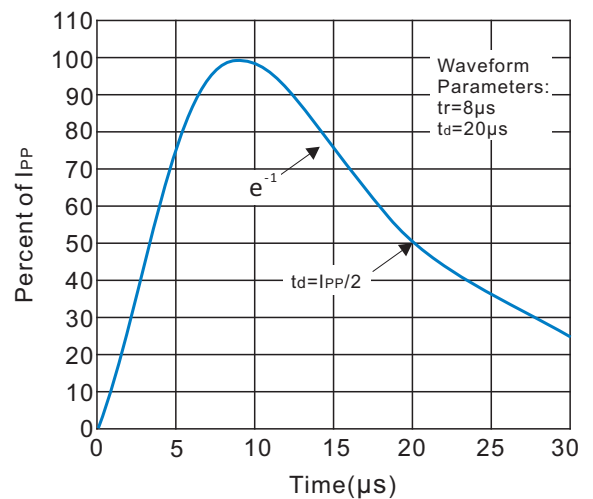
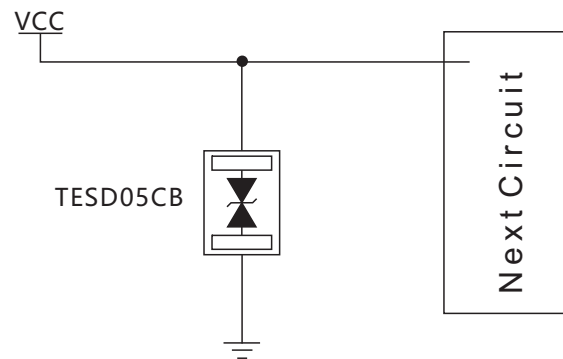


Fig.2 Pulse Waveform



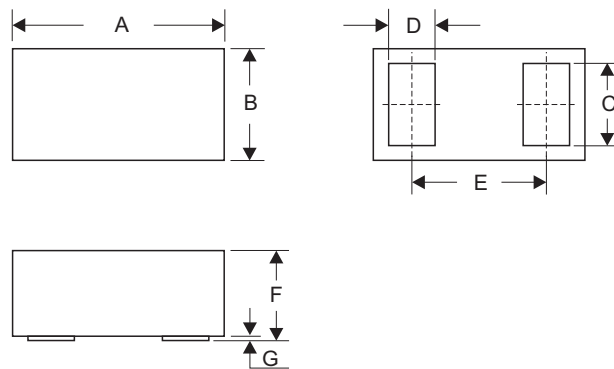
Application

Power Protection



Dimensions(DFN1006)

DFN1006



DIM	Millimeters		Inches	
	Min	Max	Min	Max
A	0.95	1.07	0.037	0.042
B	0.55	0.65	0.022	0.026
C	0.45	0.55	0.017	0.022
D	0.20	0.30	0.008	0.012
E	0.65BSC		0.026BSC	
F	0.40	0.55	0.015	0.022
G	0.00	0.10	0.000	0.004

Recommended Mounting Pad Layout

